

ΙΠΤΑΠΙΟΥ

FUNMAT PRO 310

Bringing High Performance Material Printing Capabilities To Professional Engineers

INTAMSYS



Thermostatic chamber and full-size printing capability



IDEX, more possibilities with multi material printing and twice as fast with sync and mirror mode



Independent filament box is able to keep the filament continously dry which ensures high-quality printing



Intelligent design and whole-process control Brings an unparalleled customer experience



The FUNMAT PRO 310 responds to the growing demands of professional engineers. It is featured with its thermostatic chamber and its full-size printing capability. The thermostatic chamber can reach up to 100 °C, to realize engineering plastics in large-scale printing (305 x 260 x 260mm). Plug & play and easy-to-remove modular IDEX design can realize multiple printing modes.

The FUNMAT PRO 310 also offers solutions for various engineering materials, such as ASA/ABS/PC/PC-ABS/PA/PA-CF.

Print with our user-friendly 3D model-slicing software to experience industrial-grade high-quality printing projects.

Technical Parameters

Technology	FFF	Print Speed	Max.120mm/s
Build Volume	Single Nozzle: 305 x 260 x 260 mm;	Nozzle Diameter	0.4mm (Optional:0.25/0.6mm)
	(12 x 10.2 x 10.2in)	Chamber Temperature	Max. 100°C (212°F)
	Dual Nozzle: 260 x 260 x 260mm	Build Plate Temperature	e Max. 160°C (320°F)
	(10.2 x 10.2 x 10.2in)	Leveling	Mesh leveling(Max. 100 points)
Printer Size	700 x 655 x 700mm	Filament Diameter	1.75mm
	27.6 x 25.8 x 27.6in	Travel Speed	Max.XY 500mm/s
Layer Thickness	0.1- 0.3mm	Resolution	ХҮ: 16µm Z: 1.25µm
Number of Nozzles	2 (IDEX)	Functions	Filament Absence Warning, Remote
Nozzle Temperature	Max.300°C (572°F)		Monitor, Remote Control, Remote Print
Voltage	100–132V/15A or	Nozzle	Quick release design, easy installatio
	200–240V/7A. 50/60 Hz	maintenance	and disassembly
Max. Power	1600W		Standalone, overall sealed, built-in
Connectivity	WiFi, Ethernet, USB	Filament Box	reusable molecular sieve to ensure
Screen	7" Touch Screen		low humidity, real-time monitoring of
Build Plate	Sprint Steel Magnetic Build Plate with		TEMP and HUM.
	Polyimide Heating Film	Number of Filament Trays	2 (Max 1Kg/pcs)
Cooling	FAN	Materials*	PA6/66, PA6-CF, PA12-CF, PC, PC-ABS
Filtering system	HEPA+Activated Carbon	Materials	ABS, ASA, PLA, HIPS, PVA
	Safety door lock, over temperature	Certification	CE, FCC, SGS
Safety Design	protection, overload protection,	Slicing Software	INTAMSUITE
	warning labels	Supported File Types	.stl/.obj/.x3d/.3mf/.stp/.iges
Safety Standards	EN60204	Operating System	Windows
Environment Temperature 15~30°C(59~86°F)		Storage Temperature	0~35°C(32~95°F)
Environment Humic	dity 30~70%	Storage Humidity	20~90%

*Printing materials are not limited to this table, recommended printing materials are fully validated on the printer.